



Maximum layer count

Maximum layer count – this number characterises the maximum number of conductive (supply, earth, signal, etc.) layers in the case of multilayer printed circuit boards. At Brandner PCB, the maximum layer count is related to the maximum possible thickness of a package which is currently 2.4 mm. The existing technology would also enable to manufacture boards with more layers, but there is no demand for such boards in the current market situation, since the necessary number of layers has decreased due to the development of the HDI technology.



ISO 9001